# onsemi

### **IGBT - Field Stop, Trench**

650 V, 75 A

## FGH75T65SHDT

#### Description

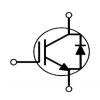
Using novel field stop IGBT technology, **onsemi's** new series of field stop 3<sup>rd</sup> generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

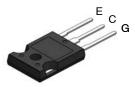
#### Features

- Maximum Junction Temperature: T<sub>J</sub> =175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V<sub>CE(sat)</sub> = 1.6 V(Typ.) @ I<sub>C</sub> = 75 A
- 100% of the Parts Tested for ILM (Note 1)
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

#### Applications

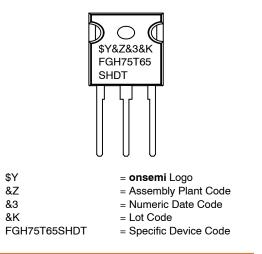
• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





TO-247-3LD CASE 340CH

#### MARKING DIAGRAMS



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS	(T <sub>C</sub> = 25°C, unless otherwise specified)
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Parameter			FGH75T65SHDT-F155	Unit
Collector to Emitter Voltage		V <sub>CES</sub>	650	V
Gate to Emitter Voltage		V <sub>GES</sub>	±20	V
Transient Gate to Emitter Voltage			±30	V
Collector Current	T <sub>C</sub> = 25°C	Ι <sub>C</sub>	150	А
Collector Current	T <sub>C</sub> = 100°C		75	А
Pulsed Collector Current (Note 1)	T <sub>C</sub> = 25°C	I <sub>LM</sub>	225	А
Pulsed Collector Current (Note 2)		I <sub>CM</sub>	225	А
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	١ <sub>F</sub>	125	А
Diode Forward Current	T <sub>C</sub> = 100°C		75	А
Pulsed Diode Maximum Forward Current (Note 2)	•	I <sub>FM</sub>	225	А
Maximum Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	PD	455	W
Maximum Power Dissipation	$T_{\rm C} = 100^{\circ}{\rm C}$		227	W
Operating Junction Temperature		TJ	–55 to +175	°C
Storage Temperature Range			–55 to +175	°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds			300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1.  $V_{CC} = 400 \text{ V}$ ,  $V_{GE} = 15 \text{ V}$ ,  $I_C = 225 \text{ A}$ ,  $R_G = 20 \Omega$ , Inductive Load 2. Repetitive Rating: Pulse width limited by max. junction temperature.

#### **THERMAL CHARACTERISTICS**

Characteristic	Symbol	FGH75T65SHDT-F155	Unit
Thermal Resistance, Junction to Case, Max. (IGBT)	$R_{\theta JC}$	0.33	°C/W
Thermal Resistance, Junction to Case, Max. (Diode)	$R_{\theta JC}$	0.65	°C/W
Thermal Resistance, Junction to Ambient, Max.	$R_{\theta JA}$	40	°C/W

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH75T65SHDT-F155	FGH75T65SHDT	TO-247-3LD	Tube	-	-	30

#### ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						-
Collector to Emitter Breakdown Voltage	BV <sub>CES</sub>	$V_{GE}$ = 0 V, I <sub>C</sub> = 1 mA	650	-	_	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES}/\Delta T_{J}$	$I_{C}$ = 1 mA, Reference to 25°C		0.6		V/°C
Collector Cut-Off Current	I <sub>CES</sub>	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I <sub>GES</sub>	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
G-E Threshold Voltage	V <sub>GE(th)</sub>	$I_{C}$ = 75 mA, $V_{CE}$ = $V_{GE}$	4.0	5.5	7.5	V
Collector to Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V	-	1.6	2.1	V

 $I_{C}$  = 75 A,  $V_{GE}$  = 15 V,  $T_{C}$  = 175°C

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#### **ELECTRICAL CHARACTERISTICS OF THE IGBT** ( $T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS		•	•			
Input Capacitance	C <sub>ies</sub>	$V_{CE} = 30 \text{ V}, \text{ V}_{GE} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	3680	_	pF
Output Capacitance	C <sub>oes</sub>		-	179	-	pF
Reverse Transfer Capacitance	C <sub>res</sub>		_	43	_	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CC}$ = 400 V, $I_C$ = 75 A, $R_G$ = 3 $\Omega, V_{GE}$ = 15 V, Inductive Load, $T_C$ = 25°C	-	28	-	ns
Rise Time	t <sub>r</sub>		-	61	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		-	86	-	ns
Fall Time	t <sub>f</sub>		-	16	-	ns
Turn-On Switching Loss	E <sub>on</sub>		-	3	-	mJ
Turn-Off Switching Loss	E <sub>off</sub>		-	0.75	-	mJ
Total Switching Loss	E <sub>ts</sub>		-	3.75	-	mJ
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 75 \text{ A},$	-	27	-	ns
Rise Time	t <sub>r</sub>	$R_G = 3 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 175^{\circ}C$	-	62	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		-	93	-	ns
Fall Time	t <sub>f</sub>		-	16	-	ns
Turn-On Switching Loss	E <sub>on</sub>		-	4.7	-	mJ
Turn-Off Switching Loss	E <sub>off</sub>		-	1.03	-	mJ
Total Switching Loss	E <sub>ts</sub>		-	5.73	-	mJ
Total Gate Charge	Qg	$V_{CE}$ = 400 V, $I_C$ = 75 A, $V_{GE}$ = 15 V	-	123	-	nC
Gate to Emitter Charge	Q <sub>ge</sub>	1	-	22.6	-	nC
Gate to Collector Charge	Q <sub>gc</sub>	1	_	44.9	-	nC

#### **ELECTRICAL CHARACTERISTICS OF THE DIODE** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Condi	Min	Тур	Max	Unit	
Diode Forward Voltage	V <sub>FM</sub>	I <sub>F</sub> = 75 A	$T_C = 25^{\circ}C$	-	1.8	2.1	V
			T <sub>C</sub> = 175°C	-	1.7	-	
Reverse Recovery Energy	E <sub>rec</sub>	$I_{\rm F} = 75  {\rm A},$	T <sub>C</sub> = 175°C	-	160	-	μJ
Diode Reverse Recovery Time	t <sub>rr</sub>	dI <sub>F</sub> /dt = 200 A/μs	$T_C = 25^{\circ}C$	-	76	-	ns
			T <sub>C</sub> = 175°C	-	270	-	1
Diode Reverse Recovery Charge	Q <sub>rr</sub>		$T_{C} = 25^{\circ}C$	-	206	-	nC
			T <sub>C</sub> = 175°C	-	2199	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

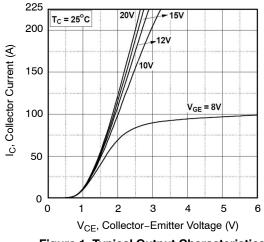


Figure 1. Typical Output Characteristics

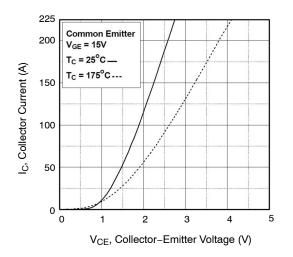
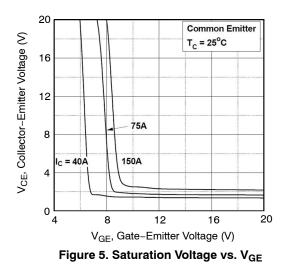


Figure 3. Typical Saturation Voltage Characteristics



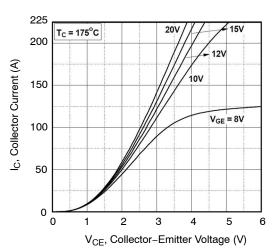


Figure 2. Typical Output Characteristics

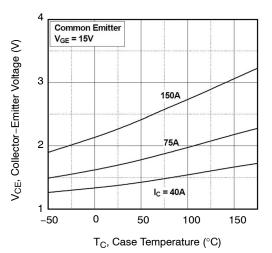
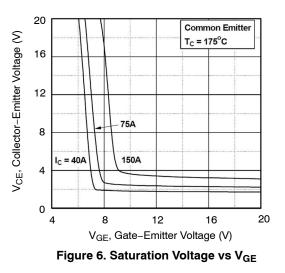
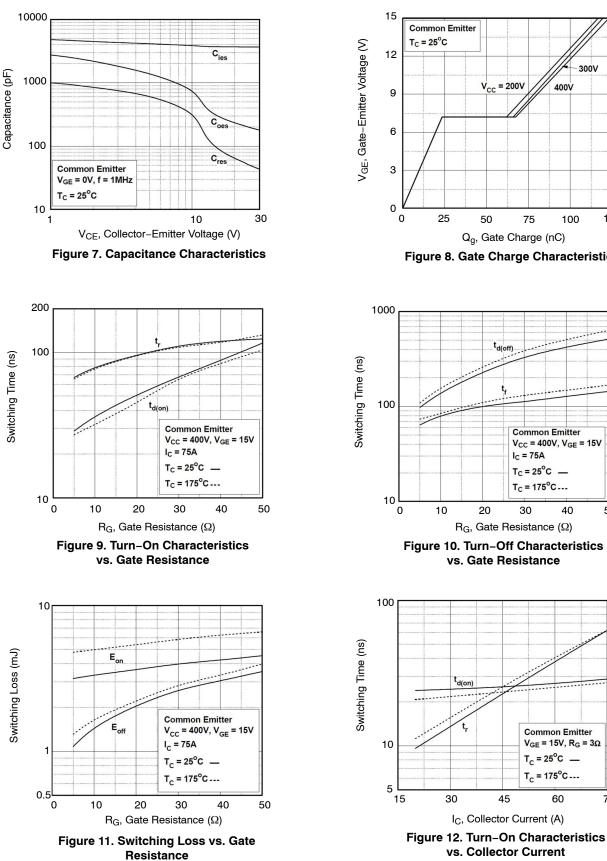


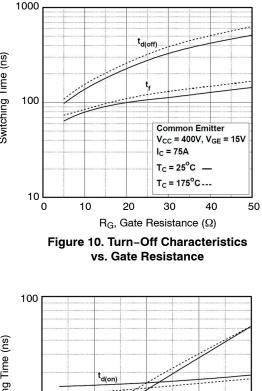
Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level



#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)



300V  $V_{\rm CC} = 200V$ 400V 125 50 75 100 Qg, Gate Charge (nC) Figure 8. Gate Charge Characteristics



Common Emitter

 $T_c = 25^{\circ}C$  —

T<sub>c</sub> = 175°C ----

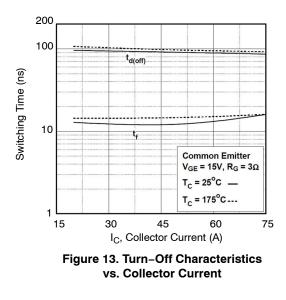
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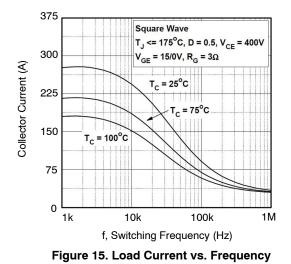
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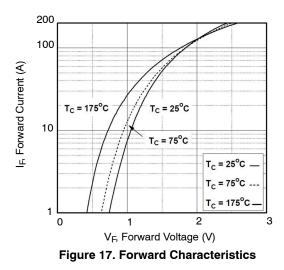
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 $V_{GE} = 15V, R_G = 3\Omega$ 

#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)







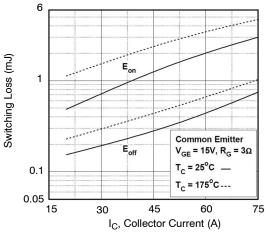
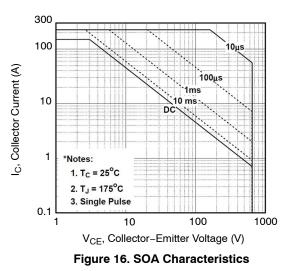
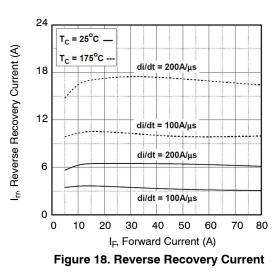
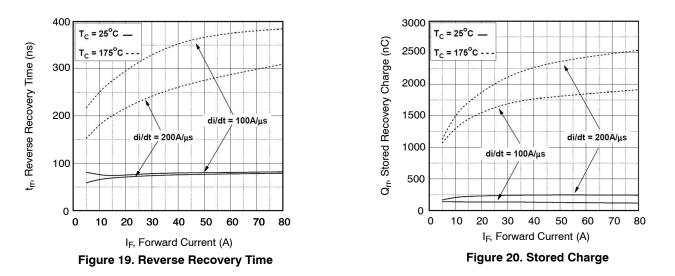


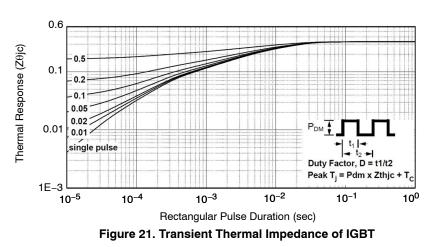
Figure 14. Switching Loss vs. Collector Current





#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)





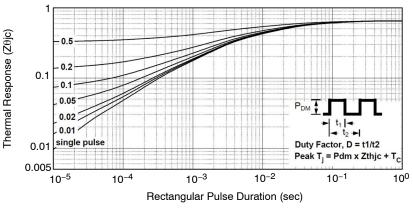
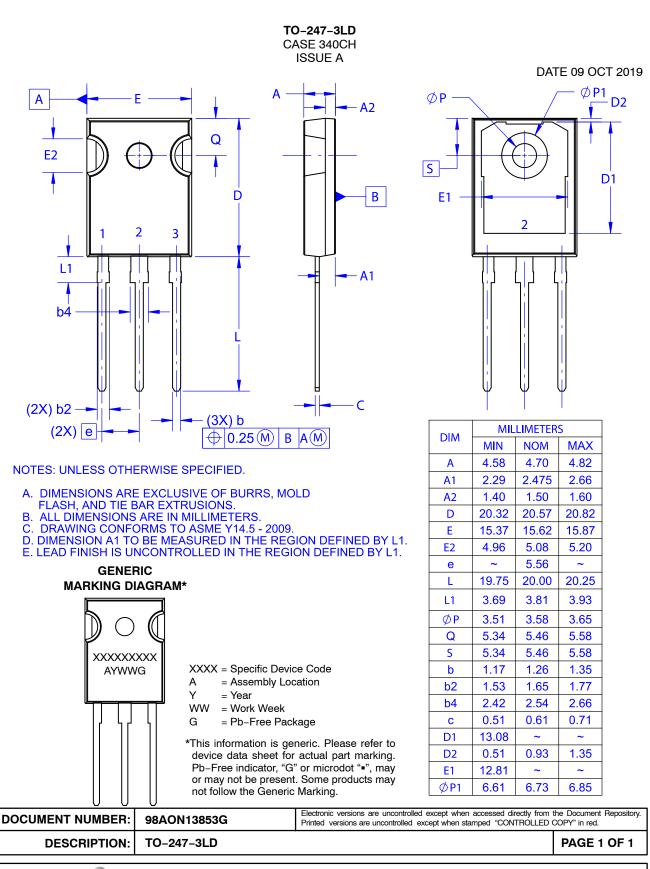


Figure 22. Transient Thermal Impedance of Diode





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